

## Gas Discharge Tubes (GDT)

## SMD5050-B Series

### Description

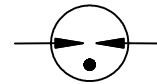
Gas discharge tubes (GDT) use noble gasses enclosed in ceramic tubes to provide an alternate circuit path for voltage spikes. The ceramic envelope and with nickel connectors allow for high loads. SMD5050 Gas Discharge Tubes (GDT) series has a surge rating of 10kA, 8/20 $\mu$ s. Offered in a Squared Surface Mount package, which helps to make pick and place on PCB process easier.

This GDT series is perfectly suited for broadband equipment applications. The GDT's low off-state capacitance is compatible with high bandwidth applications and this capacitance loading value does not vary if the voltage across the GDT changes.

SMD5050 Gas Discharge Tube (GDT) series are specifically designed for protection of electrical, multimedia, and communication equipment against over voltage transients in surface mount assembly applications.



### Electrical symbol



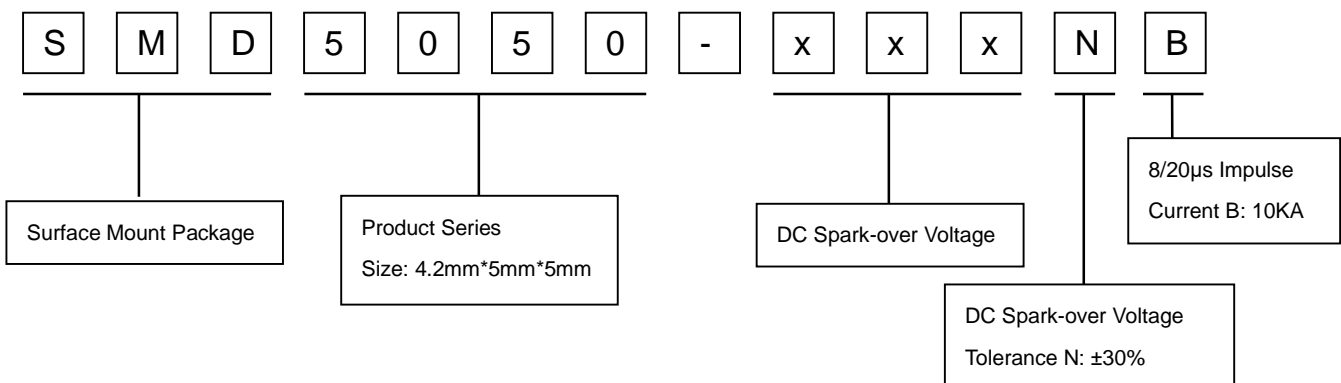
### Features

- I Excellent response to fast rising transients
- I Stable breakdown voltage
- I GHz working frequency
- I 8/20 $\mu$ s Impulse current capability:10KA
- I Surface Mount package
- I Non-Radioactive
- I Ultra Low capacitance (<0.8pF)
- I Size: 4.2mm\*5mm\*5mm
- I Storage and operational temperature: -40~+125°C

### Applications

- I CATV equipment
- I Antennas
- I RS 485
- I Telecom Base Station
- I Power Supply AC Main
- I EV power Charging
- I Inverter/Variable
- I Frequency Drivers
- I IEEE 802.3 compliant Ethernet interfaces
- I Broad Band equipment
- I xDSL, ADSL, ADSL2, VDSL, and VDSL2
- I Medical Electronics
- I Test Equipment
- I General Telecom Equipment
- I Renewable Energy

### Part Number Code



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### Electrical Characteristics

Part Number	DC Spark-over Voltage <sup>1) 2)</sup> @100V/S	Impulse Spark-over Voltage		Insulation Resistance <sup>3)</sup>	Capacitance @1MHz	Glow Voltage @10mA	Arc Voltage @1A	Life Ratings							
		100V/μS	1KV/μS					Impulse Discharge Current @8/20μS		Alternating Discharge Current @50Hz 1S	Impulse Life @10/1000μS				
		Max	Max					Min	Max	Typical	Typical	±5 times	1 time	10 times	300 times
		V	V					V	GΩ	pF	V	V	KA	KA	A
SMD5050-075NB	75±30%	500	600	1	0.8	60	10	10	12	10	100				
SMD5050-090NB	90±30%	500	600	1	0.8	60	10	10	12	10	100				
SMD5050-150NB	150±30%	500	600	1	0.8	60	10	10	12	10	100				
SMD5050-200NB	200±30%	600	700	1	0.8	60	10	10	12	10	100				
SMD5050-230NB	230±30%	600	700	1	0.8	60	10	10	12	10	100				
SMD5050-300NB	300±30%	750	850	1	0.8	60	10	10	12	10	100				
SMD5050-350NB	350±30%	800	850	1	0.8	60	10	10	12	10	100				
SMD5050-400NB	400±30%	850	950	1	0.8	60	10	10	12	10	100				
SMD5050-420NB	420±30%	850	950	1	0.8	60	10	10	12	10	100				
SMD5050-470NB	470±30%	900	1000	1	0.8	60	10	10	12	10	100				
Glow to Arc transition Current.....					<0.5A										
Weight.....					~0.42g										
Operation temperature .....					-40~+125°C										
Recommended storage <sup>5)</sup>															
- Temperature .....					+5~+35°C										
- Humidity .....					45~+80%										
- Period.....					≤ 2 years										
Climatic category (IEC 60068-1).....					40/125/21										
Marking.....					Without										
Surface treatment.....					Matte-tin plated										
Moisture sensitivity level <sup>6)</sup> .....					1										

<sup>1)</sup> At delivery AQL 0.65 level II, DIN ISO 2859.

<sup>2)</sup> In ionized mode.

<sup>3)</sup> Insulation Resistance Measuring Voltage: nominal voltage 75~150V at DC 50V, others at DC 100V.

<sup>4)</sup> Tests according to ITU-T K.12 and UL 497B.

<sup>5)</sup> Specified in terms of corrosion against tin plating.

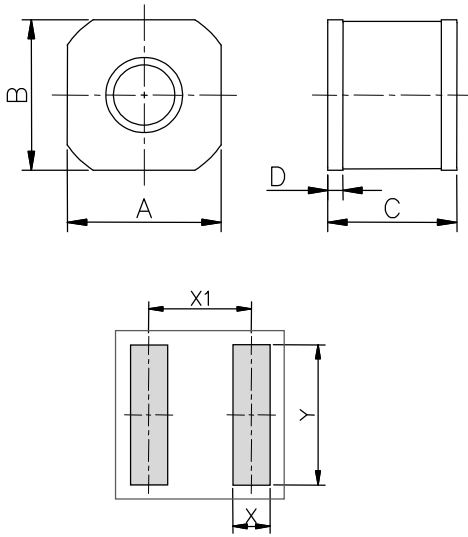
<sup>6)</sup> Tests according to JEDEC J-STD-020.

Terms and current waveforms in accordance with ITU-T K. 12, IEC61643-21 and IEC 61643-311.

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### Dimensions

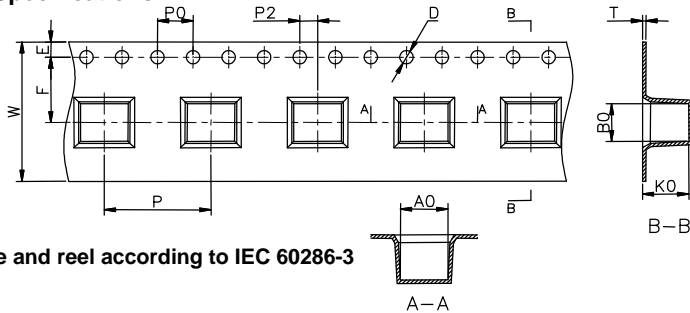


Recommended Soldering Pad Layout

Symbol	Millimeters	Inches
A	5.0±0.2	0.197±0.008
B	5.0±0.2	0.197±0.008
C	4.2±0.3	0.165±0.012
D	0.5±0.1	0.020±0.004
X	1.2	0.047
X1	4.0	0.165
Y	5.5	0.217

### Packaging Information

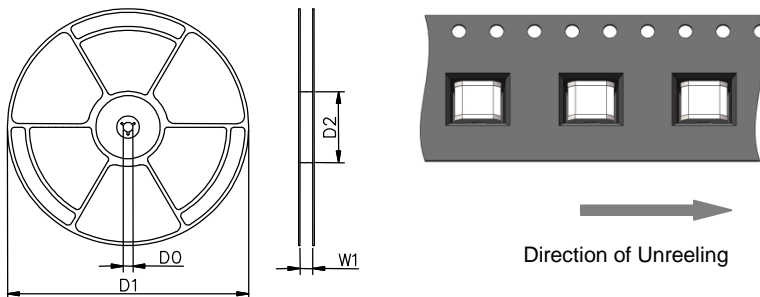
#### Tape Specifications



Tape and reel according to IEC 60286-3

Symbol	Millimeters	Inches
W	16±0.3	0.630±0.012
A0	5.3±0.1	0.209±0.004
B0	4.3±0.1	0.17±0.004
K0	5.2±0.1	0.205±0.004
P	12±0.1	0.472±0.004
F	7.5±0.1	0.295±0.004
E	1.75±0.1	0.069±0.004
D	1.5+0.1/-0.0	0.059+0.004/-0.0
P0	4±0.1	0.157±0.004
P2	2±0.1	0.079±0.004
T	0.4±0.1	0.016±0.004
D0	13.3±0.15	0.524±0.006
D1	330±2	12.992±0.079
D2	100+1/-2	3.937+0.039/-0.079
W1	16.5±0.4	0.65±0.016

#### Reel Specifications

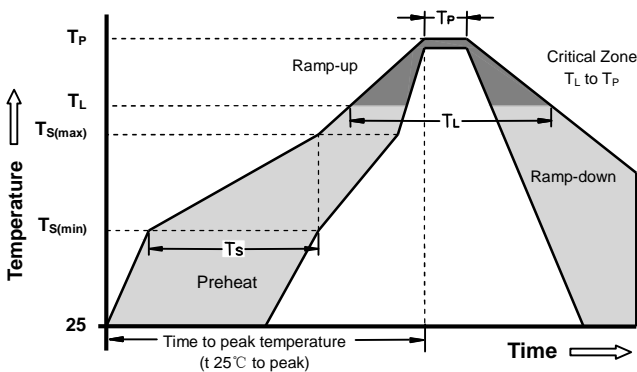


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	Reel	Inner Box	Carton
Size	330 × 17mm	340 × 333 × 70mm	375 × 353 × 380mm
Quantity	MPQ/MOQ: 1 reel=1,000pcs	1 Inner Box=3 reels=3,000pcs	1Carton=5 Inner boxes=15,000pcs
Photos			

### Soldering Parameters - Reflow Soldering (Surface Mount Devices)



Reflow Condition		Pb - Free assembly
Preheat	-Temperature Min ( $T_{s(min)}$ )	150°C
	-Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 -180 Seconds
Average ramp up rate ( Liquids Temp $T_L$ ) to peak		3°C/second max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		5°C/second max
Reflow	- Temperature ( $T_L$ ) (Liquids)	217°C
	- Time (min to max) ( $t_s$ )	60 -150 Seconds
Peak Temperature ( $T_p$ )		260 +0/-5°C
Time within 5°C of actual peak Temperature ( $t_p$ )		10 - 30 Seconds

Surface mounted components (SMD) may exhibit a temporary increase in the DC spark-over voltage after the solder reflow process. The components will recover within 24 hours. There is no quality defect nor change in protection levels during the temporary change in DC spark-over voltage.

### Terms and definitions

NO.	Item	Definitions
1	<b>Gas discharge tube(GDT)</b>	A gap, or several gaps, in an enclosed discharge medium, other than air at atmospheric pressure, designed to protect apparatus or personnel, or both, from high transient voltages. Also referred to as "gas tube surge arrester".
2	<b>DC Spark-over Voltage</b>	The voltage at which the gas discharge tube sparks over with slowly increasing d.c. voltage.
3	<b>Impulse Spark-over Voltage</b>	The highest voltage which appears across the terminals of a gas discharge tube in the period between the application of an impulse of given wave-shape and the time when current begins to flow.
5	<b>Arc voltage</b>	Voltage drop across the GDT during arc current flow.
6	<b>Glow voltage</b>	Peak value of voltage drop across the GDT when a glow current is flowing.
7	<b>Impulse discharge current 8/20<math>\mu</math>s</b>	Current impulse with a nominal virtual front time of 8 $\mu$ s and a nominal time to half-value of 20 $\mu$ s.
8	<b>Alternating Discharge Current</b>	The rms value of an approximately sinusoidal alternating current passing through the gas discharge tube.
9	<b>Insulation Resistance</b>	Insulation resistance shall be measured from each terminal to every other terminal of the GDT. The test is performed with DC50V when normal spark-over Voltage 70~150V, others with DC100V.
10	<b>Capacitance</b>	The capacitance shall be measured once at 1 MHz between all terminals unless otherwise specified.

### Cautions and warnings

- I Do not operate surge arresters in power supply networks, whose maximum operating voltage exceeds the minimum spark-over voltage of the surge arresters.
- I Surge arresters may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
- I Surge arresters must be handled with care and must not be dropped.
- I Do not continue to use damaged surge arresters.
- I The shown SMD pad dimensions represent a safe way to mount the arrester and are a recommendation of the manufacturer. During the reflow process it must be assured that no solder material reduces the insulation distance between the pads below the arrester.
- I SMD surge arresters should be soldered within 24 month after shipment.